Switching (-30V, -4.0A)

RSS040P03

●Features

- 1) Low On-resistance.
- 2) Built-in G-S Protection Diode.
- 3) Small and Surface Mount Package (SOP8).

Application

Power switching, DC / DC converter.

●Structure

Silicon P-channel MOS FET

Packaging specifications

	Package	Taping
Type	Code	ТВ
	Basic ordering unit (pieces)	2500
RSS040P03	0	

●Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit		
Drain-source voltage		Voss	-30	V		
Gate-source voltage		V _{GSS}	±20	V		
Drain current	Continuous	ID	±4.0	Α		
	Pulsed	I _{DP}	±16	A *1		
Source current	Continuous	Is	-1.6	Α		
(Body diode)	Pulsed	Isp	-16	A *1		
Total power dissipation		PD	2.0	W *2		
Channel temperature		Tch	150	°C		
Range of Storage temperature		Tstg	-55 to +150	°C		

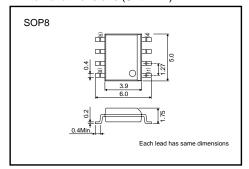
^{*1} Pw≤10μs, Duty cycle≤1% *2 Mounted on a ceramic board

●Thermal resistance (Ta=25°C)

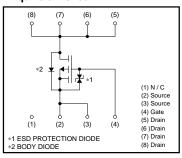
Parameter	Symbol	Limits	Unit		
Channel to ambient	Rth (ch-a)	62.5	°C / W *		

^{*} Mounted on a ceramic board.

●External dimensions (Unit : mm)



●Equivalent circuit



●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	I _{GSS}	_	-	±10	μΑ	V _{GS} =±20V, V _{DS} =0V
Drain-source breakdown voltage	V _{(BR) DSS}	-30	-	_	V	I _D = -1mA, V _{GS} =0V
Zero gate voltage drain current	IDSS	_	_	-1	μΑ	V _{DS} = -30V, V _{GS} =0V
Gate threshold voltage	V _{GS (th)}	-1.0	-	-2.5	V	V _{DS} = -10V, I _D = -1mA
		-	42	58	mΩ	I _D = -4.0A, V _G S= -10V
Static drain-source on-state resistance	R _{DS (on)} *	_	68	92	mΩ	I _D = -2.0A, V _G S= -4.5V
resistance		_	78	106	mΩ	I _D = -2.0A, V _G S= -4.0V
Forward transfer admittance	Y _{fs} *	2.5	-	-	S	V _{DS} = -10V, I _D = -2.0A
Input capacitance	Ciss	_	800	_	pF	V _{DS} = -10V
Output capacitance	Coss	_	180	_	pF	V _{GS} =0V
Reverse transfer capacitance	Crss	-	110	-	pF	f=1MHz
Turn-on delay time	t _{d (on)} *	_	12	_	ns	ID= -2.0A
Rise time	tr *	_	25	_	ns	VDD≒ -15V VGS= -10V
Turn-off delay time	t _{d (off)} *	_	45	_	ns	$\begin{array}{c} VGS = -10V \\ RL = 7.5\Omega \end{array}$
Fall time	t _f *	-	15	-	ns	Rgs=10Ω
Total gate charge	Qg	-	8.0	-	nC	V _{DD} ≒−15V
Gate-source charge	Qgs	-	2.5	-	nC	VGS=-5V
Gate-drain charge	Q _{gd}	-	3.0	-	nC	I _D =-4.0A

^{*}Pulsed

Body diode characteristics (source-drain characteristics)

body diode characteristics (source drain characteristics)						
Forward voltage	Vsn	_	_	-1.2	V	Is= -1.6A, Vgs=0V

●Electrical characteristic curves

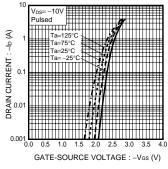


Fig.1 Typical Transfer Characteristics

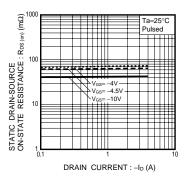


Fig.2 Static Drain-Source On-State Resistance vs. Drain Current

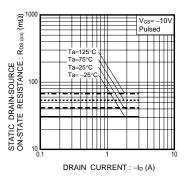


Fig.3 Static Drain-Source On-State Resistance vs. Drain Current

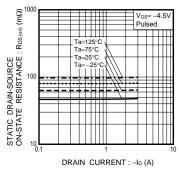


Fig.4 Static Drain-Source On-State vs. Drain Current

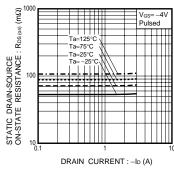


Fig.5 Static Drain-Source On-State vs. Drain Current

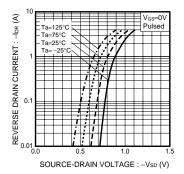


Fig.6 Reverse Drain Current Source-Drain Current

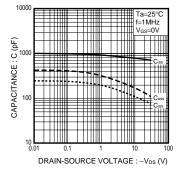


Fig.7 Typical Capacitance vs. Drain-Source Voltage

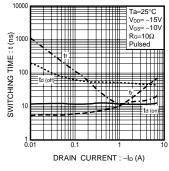


Fig.8 Switching Characteristics

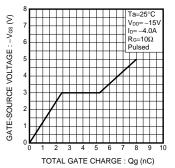


Fig.9 Dynamic Input Characteristics

●Measurement circuits

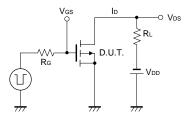


Fig.10 Switching Time Test Circuit

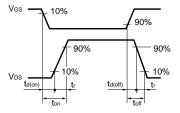


Fig.11 Switching Time Waveforms

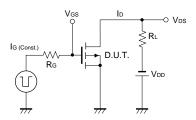


Fig.12 Gate Charge Test Circuit

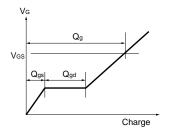


Fig.13 Gate Charge Waveform

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